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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Yaqi Cheng, et al. Docket No.: TI-28221
Serial No: 09/671,326 Art Unit: 2631
Filed: September 26, 2000 Examiner: Khanh C. Tran
Customer No.: 23494 Conf. No.: 6078
Title: Multi-Line ADSL Modem

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NAME OF INVENTOR(S):	
Yaqi Cheng, et al.	
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Multi-Line ADSL Modem	
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